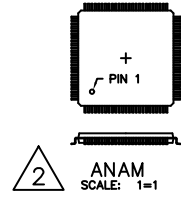
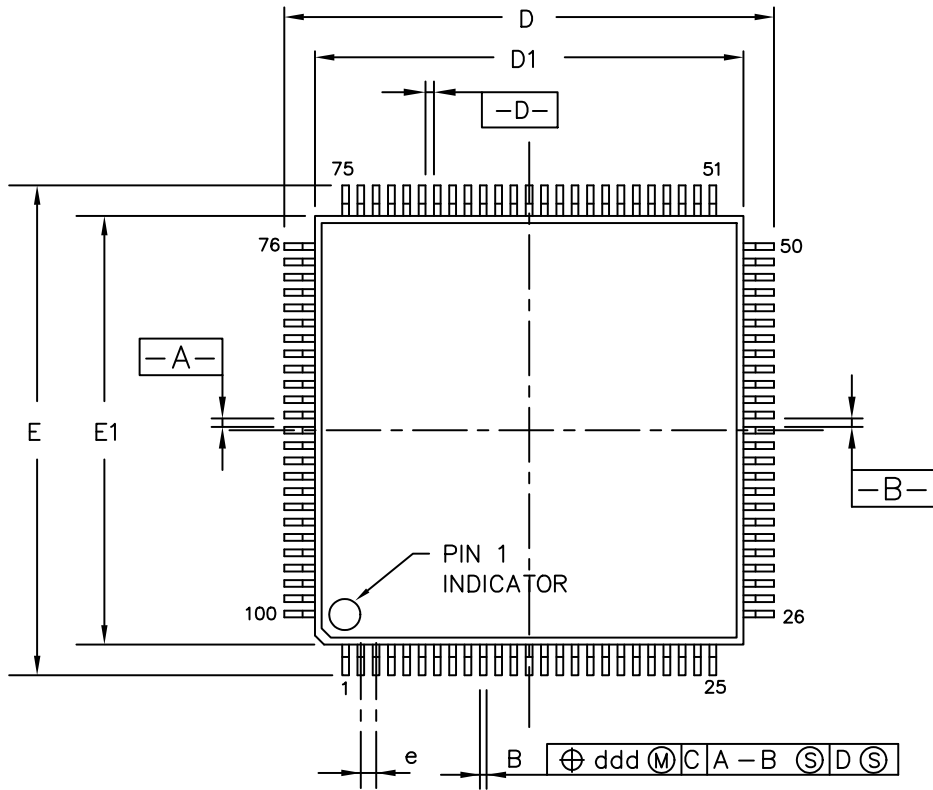


MECHANICAL CASE OUTLINE
PACKAGE DIMENSIONS

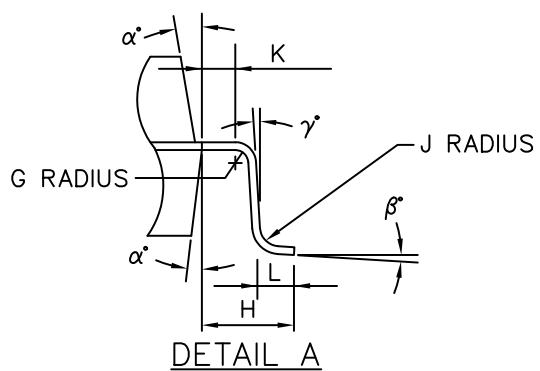
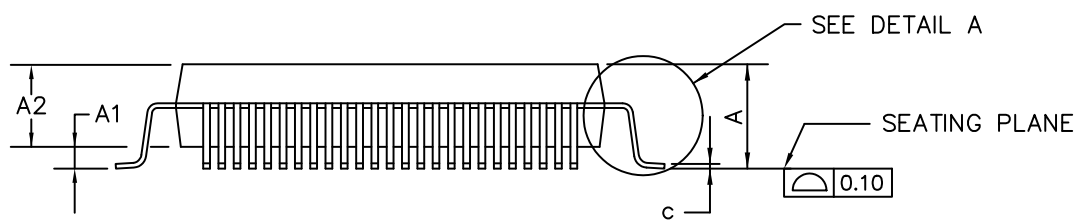


TQFP 100, 14x14
CASE 932AN-01
ISSUE O

DATE 29 JUL 2008



SYMBOL	MIN	NOM	MAX
A	-	-	1.20
A1	0.05	-	0.15
A2	0.95	1.00	1.05
D	16.00 BSC		
D1	14.00 BSC		
E	16.00 BSC		
E1	14.00 BSC		
L	0.45	0.60	0.75
e	0.50 BSC		
B	0.17	0.22	0.27
c	0.09	-	0.20
α°	11	-	13
β°	0	-	7
γ°	0	-	-
G	0.08	-	-
H	1.00 REF.		
J	0.08	-	0.20
K	0.20	-	-
ddd	-	-	0.08



1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. PACKAGE OUTSIDE FEATURES AND PIN 1 INDICATOR VARY FROM VENDOR TO VENDOR.
3. THIS PART CONFORMS TO JEDEC 95, MS-026, VARIATION "AED".

DOCUMENT NUMBER:	98AON31437E	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
STATUS:	ON SEMICONDUCTOR STANDARD	
REFERENCE:		
DESCRIPTION:	TQFP 100, 14X14	PAGE 1 OF 2

